

Diagonal 6.46 mm(Type 1/2.8) B/W CMOS Solid-state Image Sensor with Square Pixel

Description

The IMX462LLR-C is a diagonal 6.46 mm (Type 1/2.8) CMOS active pixel type solid-state image sensor with a square pixel array and 2.13 M effective pixels. This chip operates with analog 2.9 V, digital 1.2 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and no smear are achieved. This chip features an electronic shutter with variable charge-integration time.
(Application: Security cameras)

Features

- ◆ CMOS active pixel type dots
- ◆ Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Input frequency: 74.25 MHz / 37.125 MHz
- ◆ Number of recommended recording pixels: 1920 (H) × 1080 (V) approx. 2.07 M pixels
- ◆ Readout mode
 - All-pixel scan mode
 - 720p-HD readout mode
 - Window cropping mode
 - Vertical / Horizontal direction-normal / inverted readout mode
- ◆ Readout rate
 - Maximum frame rate in Full HD 1080p mode: 120 frame / s
- ◆ High dynamic range (HDR) function
 - Multiple exposure HDR
 - Digital overlap HDR
- ◆ Variable-speed shutter function (resolution 1H units)
- ◆ 10-bit / 12-bit A/D converter
- ◆ CDS / PGA function
 - 0 dB to 29.4 dB: Analog Gain 29.4 dB (step pitch 0.3 dB)
 - 29.7 dB to 71.4 dB: Analog Gain 29.4 dB + Digital Gain 0.3 to 42 dB (step pitch 0.3 dB)
- ◆ Supports I/O switching
 - Low voltage LVDS (150 m Vp-p) serial (2 ch / 4 ch / 8 ch switching) DDR output
 - CSI-2 serial data output (2 Lane / 4 Lane, RAW10 / RAW12 output)

STARVIS

* STARVIS is a registered trademark or trademark of Sony Group Corporation or its affiliates. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for security camera applications. It features a sensitivity of 2000 mV or more per $1\mu\text{m}^2$ (color product, when imaging with a 706 cd/m² light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

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Device Structure

◆ CMOS image sensor	Type 1/2.8
◆ Image size	1945 (H) × 1109 (V) approx. 2.16 M pixels
◆ Total number of pixels	1945 (H) × 1097 (V) approx. 2.13 M pixels
◆ Number of effective pixels	1937 (H) × 1097 (V) approx. 2.12 M pixels
◆ Number of active pixels	1920 (H) × 1080 (V) approx. 2.07 M pixels
◆ Number of recommended recording pixels	2.9 μm (H) × 2.9 μm (V)
◆ Unit cell size	Horizontal (H) direction: Front 0 pixel, rear 0 pixel
◆ Optical black	Vertical (V) direction: Front 10 pixels, rear 0 pixel
◆ Dummy	Horizontal (H) direction: Front 0 pixel, rear 3 pixels
	Vertical (V) direction: Front 0 pixel, rear 0 pixel
◆ Package	110 pin LGA

Image Sensor Characteristics

(T_j = 60 °C)

Item		Value	Remarks
Sensitivity	Typ.	45650 Digit/lx/s	12 bit converted value
Saturation signal	Min.	3855 Digit	12 bit converted value

Basic Drive Mode

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
Full HD 1080p	1920 (H) × 1080 (V) approx. 2.07 M pixels	120/60	LVDS CSI-2	10/12
HD 720p	1280 (H) × 720 (V) approx. 0.92 M pixels	120/60	LVDS CSI-2	10/12

